

DECLARATION FOR PATENT APPLICATION (Foreign Agent involved)

Docket Number SHX 340

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD AND APPARATUS FOR CURING ADHESIVE BETWEEN SUBSTRATES, AND DTSC, the specification of which: SUBSTRATE BONDING APPARATUS

is attached hereto

AND/OR

was filed on 07/17/2003 (MM/DD/YYYY) as United States Application Number or PCT International Application Number and was amended on (MM/DD/YYYY) (if applicable).

JAN 23 2004

10/622,357

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or (f), or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and also have identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application

Priority Not Claimed

2002-209897	Japan	18/07/2002
2002-307283	Japan	22/10/2002
2002-307385	Japan	22/10/2002
2003-188734 (Number)	Japan (Country)	30/06/2003 (Day/Month/Year Filed)

I hereby claim the benefits under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

(Application Number)	(Filing Date)	(Status – patented, pending, abandoned)
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The undersigned hereby authorizes the U.S. attorney or agent named herein to accept and follow instructions from Shiga International Patent Office as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorney or agent named herein will be so notified by the undersigned.

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith. J. Pierre Kolisch, Reg. No. 15,802; John M. McCormack, Reg. No. 26,948; Peter E. Heuser, Reg. No. 27,902; David P. Cooper, Reg. No. 33,372; Pierre C. Van Rysselberghe, Reg. No. 33,557; Walter W. Karnstein, Reg. No. 35,565; Charles H. DeVoe, Reg. No. 37,305; David S. D'Ascenzo, Reg. No. 39,952; James R. Abney, Reg. No. 42,253; Owen W. Dukelow, Reg. No. 41,002; Mark D. Alleman, Reg. No. 42,257; Michael M. Hall, Reg. No. 43,653; Christopher S. Tuttle, Reg. No. 41,357; Barbara A. McCay, Reg. No. 46,077; David E. Hall, Reg. No. 51,214; Ellen M. Gonzales, Reg. No. 44,128; Jason C. Creasman, Reg. No. 51,587; Edward B. Anderson, Reg. No. 30,154; Stanley M. Hollenberg, Reg. No. 47,658; and Anton E. Skaugset, Reg. No. 38,617. Address all telephone calls to Charles H. DeVoe at telephone number (503) 224-6655. Address all correspondence to Charles H. DeVoe at Kolisch Hartwell, P.C., 520 S.W. Yamhill Street, Suite 200, Portland, Oregon 97204.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name) Hideo Kobayashi

Inventor's signature Hideo Kobayashi Date December 26, 2003

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Additional inventors are being named on separately numbered sheets attached hereto.

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Full name of fifth inventor (given name, family name)
Inventor's signature _____ Date _____
Residence _____ Citizenship _____

Post Office Address _____

Full name of sixth inventor (given name, family name)
Inventor's signature _____ Date _____
Residence _____ Citizenship _____

Post Office Address _____